1.0 A Slew Rate Controlled Load Switch with Reverse Blocking in SC70-6, and TDFN4 1.2 mm x 1.6 mm

DESCRIPTION

The SiP32431 is a slew rate controlled high side switch with reverse blocking capability. The switch is of a low ON resistance p-channel MOSFET that supports continuous current up to 1.0 A.

The SiP32431 operates with an input voltage from 1.5 V to 5.5 V.

The SiP32431 features low input logic level to interface with low control voltage from microprocessors. This device has a very low operating current, typically 50 pA.

The SiP32431 is available in lead (Pb)-free package options including 6 pin SC70-6, and 4 pin TDFN4 1.2 mm x 1.6 mm DFN4 packages. The operation temperature range is specified from - 40 $^{\circ}$ C to + 85 $^{\circ}$ C.

The SiP32431 compact package options, operation voltage range, and low operating current make it a good fit for battery power applications.

FEATURES

- 1.5 V to 5.5 V input voltage range
- Very low $R_{DS(on)}$, typically 105 m Ω at 5 V and 135 m Ω at 3 V for TDFN4 1.2 mm x 1.6 mm package



- Typical 147 mΩ at 5 V and 178 mΩ at 3 V for SC70-6 package
- Slew rate controlled turn-on time: 100 μs
- Low quiescent current < 1 μA
- Low shutdown current < 1 μA
- Reverse blocking capability
- SC70-6 and TDFN4 1.2 mm x 1.6 mm packages
- Compliant to RoHS Directive 2002/95/EC
- Halogen-free according to IEC 61249-2-21 definition

APPLICATIONS

- · Cellular telephones
- · Digital still cameras
- · Personal digital assistants (PDA)
- Hot swap supplies
- · Notebook computers
- · Personal communication devices
- · Portable Instruments

TYPICAL APPLICATION CIRCUIT

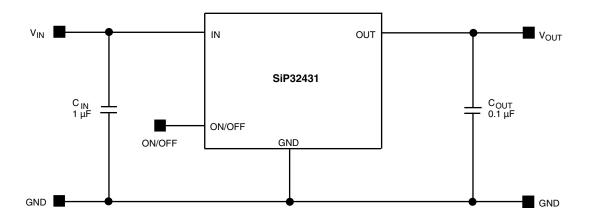


Figure 1 - SiP32431 Typical Application Circuit



ORDERING INFORMATION					
Temperature Range	Package	Marking	Part Number		
- 40 °C to 85 °C	SC70-6	MAxx	SiP32431DR3-T1GE3		
- 40 C to 85 C	TDFN4 1.2 mm x 1.6 mm	ADx	SiP32431DNP3-T1GE4		

Notes:

x = Lot Code

-GE3 denotes halogen-free and RoHS compliant

Please use the SiP32431DR3-T1GE3 to replace SiP32431DR3-T1-E3

ABSOLUTE MAXIMUM RATING	GS			
Parameter	Limit	Unit		
Supply Input Voltage (V _{IN})		- 0.3 to 6		
Enable Input Voltage (V _{ON/OFF})		- 0.3 to 6	V	
Output Voltage (V _{OUT})		- 0.3 to V _{IN} + 0.3		
Maximum Continuous Switch Current (I _{MAX})	SC70-6 package	1.2		
Maximum Continuous Switch Current (I _{MA)}	TDFN4 1.2 mm x 1.6 mm	1.4	A	
Maximum Pulsed Current (I _{DM}) V _{IN} (Pulsed at 1 ms, 10 % Duty Cycle)	V _{IN} ≥ 2.5 V	3		
	V _{IN} < 2.5 V	1.6		
ESD Rating (HBM)		4000	V	
Junction Temperature (T _J)		- 40 to 125	°C	
Thermal Desigtance (0)8	6 pin SC70-6 ^b	220	°C/W	
Thermal Resistance (θ _{JA}) ^a	4 pin TDFN4 1.2 mm x 1.6 mm ^c	170] 30/00	
Dower Discipation /D \a	6 pin SC70-6 ^b	250	ma\A/	
Power Dissipation (P _D) ^a	4 pin TDFN4 1.2 mm x 1.6 mm ^c	324	mW	

Notes:

- a. Device mounted with all leads and power pad soldered or welded to PC board.
- b. Derate 4.5 mW/°C above $T_A = 70$ °C.
- c. Derate 5.9 mW/ $^{\circ}$ C above $T_{A} = 70 \,^{\circ}$ C, see PCB layout.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating/conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING RANGE				
Parameter	Limit	Unit		
Input Voltage Range (V _{IN})	1.5 to 5.5	V		
Operating Temperature Range	- 40 to 85	°C		





		Test Conditions Unless Speci $V_{IN} = 5.0$, $T_A = -40$ °C to 85 °	Limits - 40 °C to 85 °C				
Parameter	Symbol	(Typical values are at $T_A = 25^{\circ}$	°C)	Min.a	Typ. ^b	Max. ^a	Unit
Operating Voltage ^c	V _{IN}			1.5	-	5.5	V
Quiescent Current	ΙQ	On/Off = active		-	0.00005	1	
Off Supply Current	I _{Q(off)}	On/Off = inactive, Out = oper	n	-	-	1	
Off Switch Current	I _{SD(off)}	On/Off = inactive, Out = 0		-	-	1	μΑ
Reverse Blocking Current	I _{RB}	V _{OUT} = 5.5 V, V _{IN} = 0, V _{on/off} = ina	active	-	0.13	1	1
		V 5VI 500 mA T 05 °C	SC70-6	-	147	000	
		$V_{IN} = 5 \text{ V}, I_L = 500 \text{ mA}, T_A = 25 \text{ °C}$	TDFN4	-	105	230	
		V 40VI 500 WA T 05 00	SC70-6	-	155	250	1
	R _{DS(on)}	$V_{IN} = 4.2 \text{ V}, I_L = 500 \text{ mA}, T_A = 25 ^{\circ}\text{C}$	TDFN4	-	110		mΩ
On Basistanas		V _{IN} = 3 V, I _L = 500 mA, T _A = 25 °C	SC70-6	-	178	290	
On-Resistance			TDFN4	-	135		
		V 10VI 500 TA T 05 00	SC70-6	-	275	480	
		$V_{IN} = 1.8 \text{ V}, I_L = 500 \text{ mA}, T_A = 25 \text{ °C}$	TDFN4	-	230		
		V _{IN} = 1.5 V, I _L = 500 mA, T _A = 25 °C	SC70-6	-	395	520	
			TDFN4	-	350		
On-Resistance TempCoefficient	TD _{RDS}		•	-	2800	-	ppm/°(
	V _{IL}	V _{IN} ≥ 1.5 V to < 1.8 V	-	-	0.3	V	
On/Off Input Low Voltage ^c		V _{IN} ≥ 1.8 V to < 2.7 V	-	-	0.4		
		$V_{IN} \ge 2.7 \text{ V to} \le 5.5 \text{ V}$	-	-	0.6		
	V _{IH}	V _{IN} ≥ 1.5 V to < 2.7 V		1.3	-	-]
On/Off Input Low Voltage ^c		V _{IN} ≥ 2.7 V to < 4.2 V	1.5	-	-	7	
		$V_{IN} \ge 4.2 \text{ V to} \le 5.5 \text{ V}$		1.8	-	-	1
On/Off Input Leakage	I _{SINK}	V _{On/Off} = 5.5 V		-	-	1	μΑ
Output Turn-On Delay Time	t _{d(on)}			-	20	40	
Output Turn-On Rise Time	t _(on)	$V_{IN} = 5 \text{ V}, R_{LOAD} = 10 \Omega, T_A = 25$	5 °C	-	140	180	μs
Output Turn-Off Delay Time	t _{d(off)}			-	4	10	1

a. The algebriac convention whereby the most negative value is a minimum and the most positive a maximum.

b. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing c. For V_{IN} outside this range consult typical ON/OFF threshold curve.

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PIN CONFIGURATION

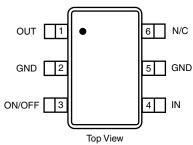


Figure 2 - SC70-6 Package

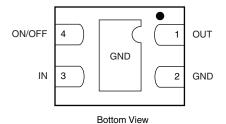


Figure 3 - TDFN4 1.2 mm x 1.6 mm Package

PIN DES	CRIPTIO	N	
Pin N	umber		
SC70-6	TDFN4	Name	Function
4	3	IN	This pin is the p-channel MOSFET source connection. Bypass to ground through a 1 μF capacitor.
2, 5	2	GND	Ground connection
3	4	ON/OFF	Enable input
1	1	OUT	This pin is the p-channel MOSFET drain connection. Bypass to ground through a 0.1 µF capacitor.

TYPICAL CHARACTERISTICS (internally regulated, 25 °C, unless otherwise noted)

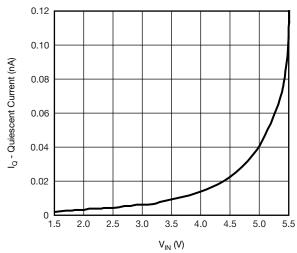


Figure 4 - Quiescent Current vs. Input Voltage

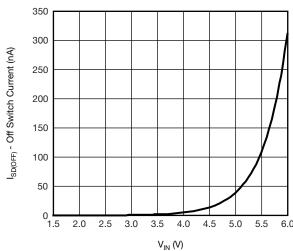


Figure 6 - Off Switch Current vs. Input Voltage

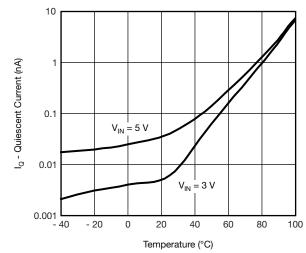


Figure 5 - Quiescent Current vs. Temperature

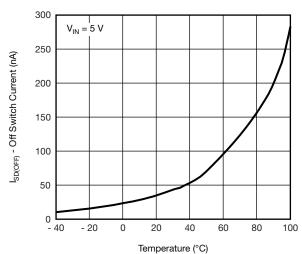


Figure 7 - Off Switch Current vs. Temperature





TYPICAL CHARACTERISTICS (internally regulated, 25 °C, unless otherwise noted)

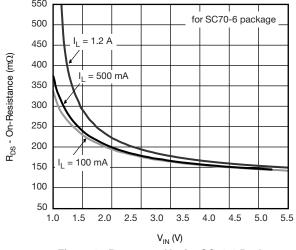


Figure 8 - R_{DS(on)} vs. V_{IN} for SC70-6 Package

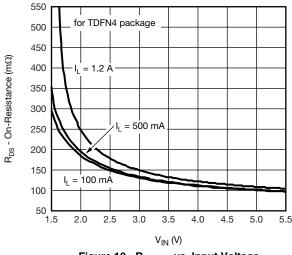


Figure 10 - R_{DS(on)} vs. Input Voltage

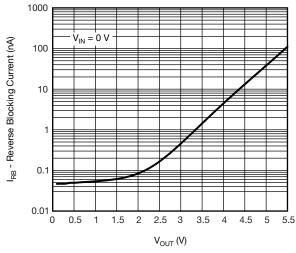


Figure 12 - Reverse Blocking Current vs. V_{OUT}

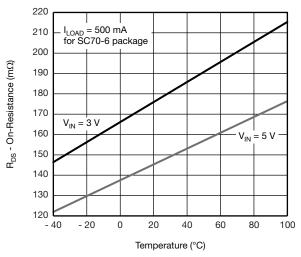


Figure 9 - R_{DS(on)} vs. Temperature

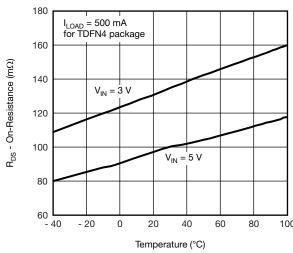


Figure 11 - R_{DS(on)} vs. Temperature

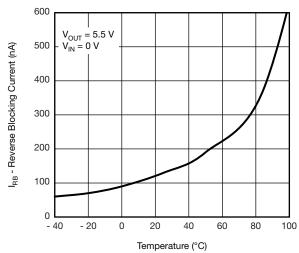


Figure 13 - Reverse Blocking Current vs. Temperature

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TYPICAL CHARACTERISTICS (internally regulated, 25 °C, unless otherwise noted)

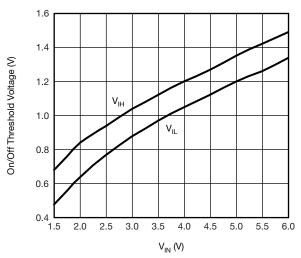


Figure 14 - ON/OFF Threshold vs. Input Voltage

TYPICAL WAVEFORMS

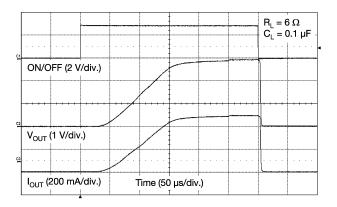


Figure 15 - Switching $(V_{IN} = 3 V)$

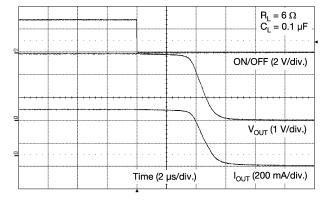


Figure 16 - Turn-Off (V_{IN} = 3 V)

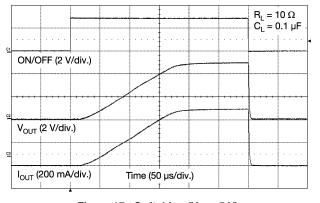


Figure 17 - Switching $(V_{IN} = 5 V)$

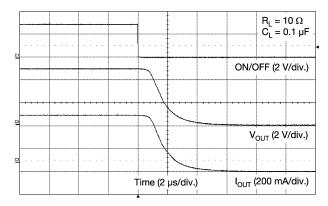


Figure 18 - Turn-Off ($V_{IN} = 5 V$)





BLOCK DIAGRAM

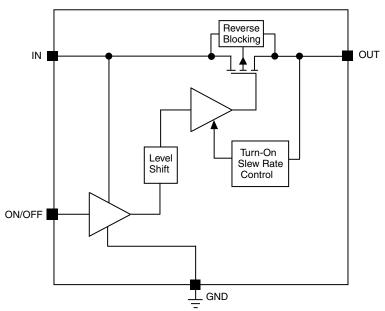
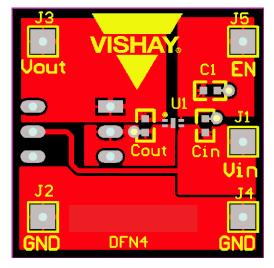
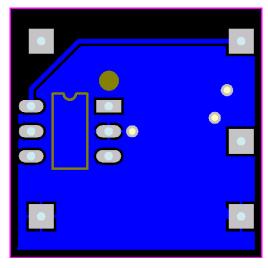


Figure 19 - Functional Block Diagram

PCB LAYOUT





Top Bottom

Figure 20 - TDFN4 1.2 mm x 1.6 mm PCB Layout

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DETAILED DESCRIPTION

The SiP32431 is a P-Channel MOSFET power switches designed for high-side slew rate controlled load-switching applications. Once turned on, the slew-rate control circuitry is activated and current is ramped in a linear fashion until it reaches the level required for the output load condition. This is accomplished by first elevating the gate voltage of the MOSFET up to its threshold voltage and then by linearly increasing the gate voltage until the MOSFET becomes fully enhanced. At this point, the gate voltage is then quickly increased to the full input voltage to reduce R_{DS(on)} of the MOSFET switch and minimize any associated power losses.

APPLICATION INFORMATION

Input Capacitor

While a bypass capacitor on the input is not required, a 1 μ F or larger capacitor for C_{IN} is recommended in almost all applications. The bypass capacitor should be placed as physically close as possible to the SiP32431 to be effective in minimizing transients on the input. Ceramic capacitors are recommended over tantalum because of their ability to withstand input current surges from low impedance sources such as batteries in portable devices.

Output Capacitor

A 0.1 μF capacitor or larger across V_{OUT} and GND is recommended to insure proper slew operation. C_{OUT} may be increased without limit to accommodate any load transient condition with only minimal affect on the SiP32431 turn on slew rate time. There are no ESR or capacitor type requirement.

Enable

The On/Off pin is compatible with both TTL and CMOS logic voltage levels.

Protection Against Reverse Voltage Condition

The SiP32431 contains a body snatcher that normally connect the body to the Source (IN) when the device is enable. In case where the device is disabled but the V_{OUT} is higher than the V_{IN} , the n-type body is switched to OUT, reverse bias the body diode to prevent the current from going back to the input.

Thermal Considerations

The SiP32431 is designed to maintain a constant output load current. Due to physical limitations of the layout and assembly of the device the maximum switch current is 1.0 A, as stated in the Absolute Maximum Ratings table. However, another limiting characteristic for the safe operating load current is the thermal power dissipation of the package. To obtain the highest power dissipation (and a thermal resistance of 170 °C/W) the power pad of the device should be connected to a heat sink on the printed circuit board.

The maximum power dissipation in any application is dependant on the maximum junction temperature, $T_{J(MAX)}$ = 125 °C, the junction-to-ambient thermal resistance for the TDFN4 1.2 mm x 1.6 mm package, θ_{J-A} = 170 °C/W, and the ambient temperature, T_A , which may be formulaically expressed as:

P (max.) =
$$\frac{T_J (max.) - T_A}{\theta_{J-A}} = \frac{125 - T_A}{170}$$

It then follows that, assuming an ambient temperature of 70 °C, the maximum power dissipation will be limited to about 324 mW.

So long as the load current is below the 1.0 A limit, the maximum continuous switch current becomes a function two things: the package power dissipation and the $R_{DS(on)}$ at the ambient temperature.

As an example let us calculate the worst case maximum load current at T_A = 70 °C. The worst case $R_{DS(on)}$ at 25 °C occurs at an input voltage of 1.5 V and is equal to 520 m Ω . The $R_{DS(on)}$ at 70 °C can be extrapolated from this data using the following formula

 $R_{DS(on)}$ (at 70 °C) = $R_{DS(on)}$ (at 25 °C) x (1 + T_{C} x $\Delta T)$ Where T_{C} is 3300 ppm/°C. Continuing with the calculation we have

 $R_{DS(on)}$ (at 70 °C) = 520 m Ω x (1 + 0.0033 x (70 °C - 25 °C)) = 597 m Ω

The maximum current limit is then determined by

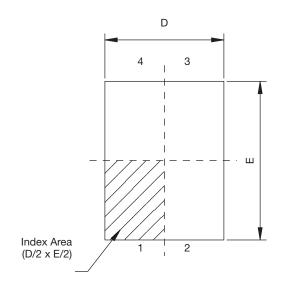
$$I_{LOAD}$$
 (max.) < $\sqrt{\frac{P \text{ (max.)}}{R_{DS(on)}}}$

which in case is 0.74 A. Under the stated input voltage condition, if the 0.74 A current limit is exceeded the internal die temperature will rise and eventually, possibly damage the device.

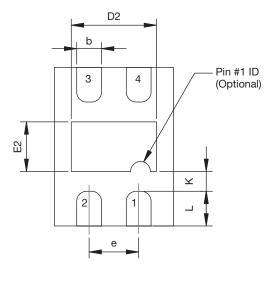
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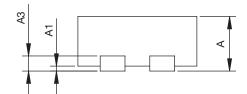
TDFN4 1.2 x 1.6 CASE OUTLINE



Top View



Bottom View



Side View

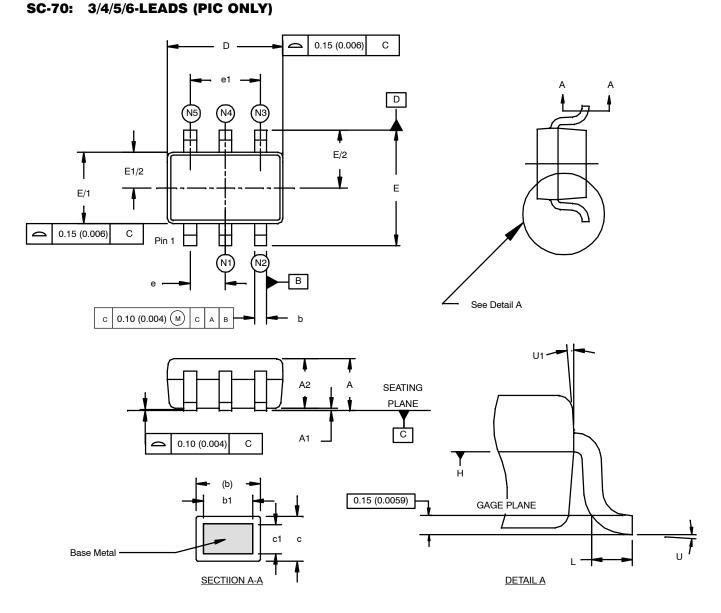
DIM.		MILLIMETERS		INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.50	0.55	0.60	0.020	0.022	0.024	
A1	0.00	-	0.05	0.00	-	0.002	
A3		0.15 REF			0.006		
b	0.20	0.25	0.30	0.008	0.010	0.012	
D	1.15	1.20	1.25	0.045	0.047	0.049	
D2	0.81	0.86	0.91	0.032	0.034	0.036	
е	0.50 BSC 0.				0.020		
E	1.55	1.60	1.65	0.061	0.063	0.065	
E2	0.45	0.50	0.55	0.018	0.020	0.022	
K	0.20	-	-	0.008	-	-	
L	0.30	0.35	0.40	0.012	0.014	0.016	

ECN: C10-0043-Rev. A, 08-Feb-10

DWG: 5995

Document Number: 65734 Revision: 08-Feb-10





Pin	LEAD COUNT					
Code	3	4	5	6		
N1	-	_	2	2		
N2	2	2	3	3		
N3	-	3	4	4		
N4	3	_	-	5		
N5	-	4	5	6		

NOTES:

- 1. Dimensioning and tolerancing per ANSI Y14.5M-1994.
- Controlling dimensions: millimeters converted to inch dimensions are not necessarily exact.
- Dimension "D" does not include mold flash, protrusion or gate burr. Mold flash, protrusion or gate burr shall not exceed 0.15 mm (0.006 inch) per side.
- 4. The package top shall be smaller than the package bottom. Dimension "D" and "E1" are determined at the outer most extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.

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19-Nov-04 to the control of the control of



	М	ILLIMETE	RS	INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.80	-	1.10	0.031	-	0.043	
A 1	0.00	-	0.10	0.000	-	0.004	
A2	0.80	0.90	1.00	0.031	0.035	0.040	
b	0.15	-	0.30	0.006	-	0.012	
b1	0.15	0.20	0.25	0.006	0.008	0.010	
С	0.08	-	0.25	0.003	-	0.010	
с1	0.08	0.13	0.20	0.003	0.005	0.008	
D	1.90	2.10	2.15	0.074	0.082	0.084	
E	2.00	2.10	2.20	0.078	0.082	0.086	
E ₁	1.15	1.25	1.35	0.045	0.050	0.055	
е		0.65 BSC			0.0255 BSC		
e ₁		1.30 BSC		0.0512 BSC			
L	0.26	0.36	0.46	0.010	0.014	0.018	
U	0°	-	8°	0°	_	8°	
U1	4°		10°	4°		10°	

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